Mobile Devices Ingénierie

100 Avenue de Stalingrad, 94800 Villejuif, France

Date: June 6, 2018

Product Equality Declaration

We, Mobile Devices Ingénierie, declare on our sole responsibility for the product of C4D-4MUSAA_V6 (Model #1) and C4D-4MUSAB_V6 (Model #2) share the same PCB Layout, but have some differences as described below:

1. Product information

Model number:

Model #1: C4D-4MUSAA_V6Model #2: C4D-4MUSAB_V6

HW version:

Model #1: SAP00388-335
Model #2: SAP00341-328

2. Hardware difference

The difference between Model#1 and Model #2 is the additional multiplexed OBD for Model #1 Except listings above, the others are all the same.

The table below gives the difference between SAP00328 and SAP00335;

Designator	Description	SAP00328	SAP00335
C139	Capacitor ceramic 100nF ±10% 0402 10V X7R		•
C14, C52, C54	Capacitor ceramic 33pF ±5% 0402 50V COG		•
C140	Capacitor ceramic 100nF ±10% 0201 6.3V X5R		e e
C141	Capacitor ceramic 100pF ±5% 0402 50V X7R		
C142	Capacitor ceramic 100nF ±10% 0603 50V X7R		
D22, D23	CAN bus ESD protection diode, PESD1CAN-UX, Nexperia		•
L10, L11, L12	SMD EMI Suppression Ferrite Beads WE-CBF, 742792780, Würth		•
P1, P3, P8	OBD connector short pin (P1 to P3 and P6 to P8) for OBD Dongle V4, rev AC, MME00203AC, BOSI		
Q21, Q22, Q43, Q24	Photocoupler photo relay, TLP3212(TP15,F), Toshiba		•

Designator	Description	SAP00328	SAP00335
Q27	NPN General Purpose Transistor, BC847BW		
R137, R138, R139, R140	Resistor 300R ±1% 0201 1/20W		•
R141	Resistor 6.49K ±1% 0805 1/8W		•
R162	Resistor 470K ±5% 0603 1/10W		- 15 16 1
R164	Resistor 1M ±5% 0201 1/20W		•
R165	Resistor 3.3K ±5% 0201 1/20W		•
U17	High-speed CAN transceiver with Standby mode, TJA1042TK/3/1J, NXP		•
U7	Single Wire CAN Transceiver, NCV7356D1G, On Semi		•
U12	16-bit Digital Signal Controllers, 128 KB Flash, 16 KB SRAM, dual CAN controller, dsPIC33EP128GM706T-I/MR, Microchip		
U12	16-bit Digital Signal Controllers, 128 KB Flash, 16 KB SRAM, CAN controller, dsPIC33EP128GP506T-I/MR, Microchip	•	

The table below gives the difference between SAP00341 and SAP00388:

Designator	Description	SAP00341	SAP00388
C305	Capacitor ceramic 33pF ±5% 0402 50V COG		
L306	SMD EMI Suppression Ferrite Beads WE-CBF, 742792780, Würth		•
P11	OBD connector short pin for OBD Dongle V2, MME00081AB, BOSI		•

This difference will not affect communications performance.

Should you have any questions or comments regarding this matter, please have my best attention.

Sincerely yours,

MOBILE DEVICES ING. 100 AV. DE STALINGRAD 94 BOD VILLEJUIF 01.42.11.93 25

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COMPANY: Mobile Devices Ingénierie

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Mobile Devices Ingénierie

100 Avenue de Stalingrad, 94800 Villejuif, France

Date: April 19, 2018

Product Equality Declaration

We, Mobile Devices Ingénierie, declare on our sole responsibility for the product of C4D-4MUSAA_V6 (Model #1) is exactly the same as C4D-4MUSAB_V6 (Model #2) as below:

1. Product information

Model number:

Model #1: C4D-4MUSAA_V6Model #2: C4D-4MUSAB_V6

HW version:

Model #1: SAP00388-335
Model #2: SAP00341-328

2. Hardware difference

The difference between Model#1 and Model #2 is the additional multiplexed OBD for Model #1 Except listings above, the others are all the same.

Should you have any questions or comments regarding this matter, please have my best attention.

Sincerely yours,

Contact Person: Charles NTEP

COMPANY: Mobile Devices Ingénierie

Tel: +33142111243

E-Mail: charles.ntep@mobile-devices.fr

Mobile Devices Ingénierie

100 Avenue de Stalingrad, 94800 Villejuif, France

Date: April 26, 2018

Product Equality Declaration

We, Mobile Devices Ingénierie, declare on our sole responsibility for the product of C4D-4MUSAA_V6 (Model #1) and C4D-4MUSAB_V6 (Model #2) share the same PCB Layout and block diagram, but have some differences as described below:

1. Product information

Model number:

Model #1: C4D-4MUSAA_V6

Model #2: C4D-4MUSAB_V6

HW version:

Model #1: SAP00388-335

Model #2: SAP00341-328

2. Hardware difference

The difference between Model#1 and Model #2 is the additional multiplexed OBD for Model #1 Except listings above, the others are all the same.

For more details, find the resume below:

SOFTWARE MODIFICATIONS:

Protocol Stack changes: NO

MMS/STK changes: NO

JAVA changes: NO

Other changes detailed: NO

HARDWARE MODIFICATION:

Band changes: NO

Power Amplifier changes: NO

Antenna changes: NO

PCB Layout changes: NO.

Components on PCB changes: Yes

Bluetooth changes: NO

FM changes: NO Other changes: NO

MECHANICAL MODIFICATIONS:

Use new metal front/back cover or keypad: NO

Mechanical shell changes: NO Other changes detailed: NO

ACCESSORY MODIFICATIONS:

Battery changes: NO

This difference will not affect communications performance.

Should you have any questions or comments regarding this matter, please have my best attention.

Sincerely yours,

Contact Person: Charles NTEP

COMPANY: Mobile Devices Ingénierie

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